imall

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4-Channel ESD/EMI Filter Array Plus 4-Channel ESD Array for USB

CM1401-32CP

Features

- Functionally and pin-compatible with CSPEMI307A device
- OptiGuard coated for improved reliability at assembly
- Four channels of combined EMI/RFI filtering + ESD protection
- Four additional channels of ESD-only protection
- 40dB absolute attenuation (typical) at 1GHz
- 35dB attenuation (typical) at 1GHz relative to pass band
- ±15kV ESD protection on all channels (IEC 61000-4-2 Level 4, contact discharge)
- ±30kV ESD protection on all channels (HBM)
- 15-bump, 2.960mm X 1.330mm footprint
- Chip Scale Package (CSP) features extremely low
 lead inductance for optimum filter and ESD

performance

RoHS-compliant (lead-free) finishing

Applications

- EMI filtering and ESD protection for both data and I/O ports
- Outer four channels provide ESD protection for USB lines and other I/O port applications
- Wireless handsets
- Handheld PCs / PDAs
- MP3 players
- Notebooks
- Desktop PCs

Product Description

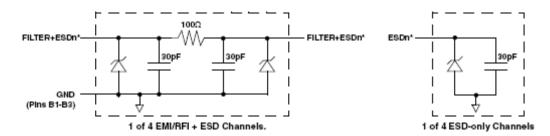
The CM1401-32CP is a multichannel array with four low-pass filter + ESD channels and four ESD-only channels. The CM1401-32CP reduces EMI/RFI emissions on a data port and protects against ESD on a USB port. Each EMI/RFI channel integrates a high quality pi-style filter (C-R-C) that provides greater than 30dB attenuation in the 800-2700 MHz range relative to the pass band attenuation. These pi-style filters are bidirectional, controlling EMI both to and from a data port connector.

The CM1401-32CP provides a high-level of ESD protection on all eight channels for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The input pins safely dissipate ESD strikes of ± 15 kV, exceeding the maximum requirement of the IEC 61000-4-2 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the device provides protection for contact discharges to greater than ± 30 kV.

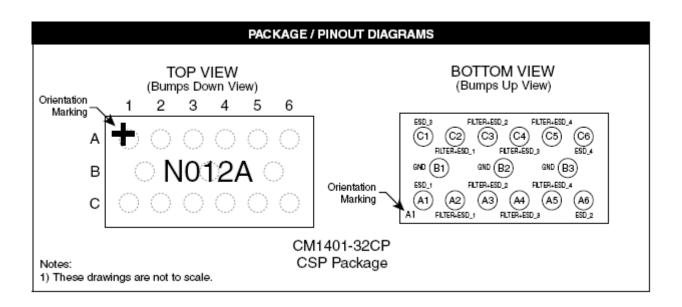
The CM1401-32CP is particularly well suited for portable electronics (e.g., cellular telephones, PDAs, notebook computers) because of its small package footprint and low weight.

The CM1401-32CP incorporates *OptiGuard*[™] coating for improved reliability at assembly and comes in a space-saving, low-profile Chip Scale Package with RoHS-compliant lead-free finishing.

Electrical Schematic



* See Package/Pinout Diagram for expanded pin information



CM1401-32CP

	PIN DESCRIPTIONS					
PIN(s)	NAME	DESCRIPTION				
A1	ESD_1	ESD Channel 1				
A2	FILTER+ESD_1	Filter + ESD Channel 1				
A3	FILTER+ESD_2	Filter + ESD Channel 2				
A4	FILTER+ESD_3	Filter + ESD Channel 3				
A5	FILT ER+ESD_4	Filter + ESD Channel 4				
A6	ESD_2	ESD Channel 2				
B1-B3	GND	Device Ground				
C1	ESD_3	ESD Channel 3				
C2	FILTER+ESD_1	Filter + ESD Channel 1				
C3	FILTER+ESD_2	Filter + ESD Channel 2				
C4	FILTER+ESD_3	Filter + ESD Channel 3				
C5	FILTER+ESD_4	Filter + ESD Channel 4				
C6	ESD_4	ESD Channel 4				

Ordering Information

PART NUMBERING INFORMATION							
Pins	Package	Variation	Ordering Part Number ¹	Part Marking			
15	CSP	SAC387	CM1401-32CP	N012A			

Note 1: Parts are shipped in Tape and Reel form unless otherwise specified.

Specifications

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	RATING	UNITS				
Storage Temperature Range	-65 to +150	°C				
DC Power per Resistor	100	mW				
DC Package Power Rating	600	mW				

STANDARD OPERATING CONDITIONS							
PARAMETER	RATING	UNITS					
Operating Temperature Range	-40 to +85	°C					

CM1401-32CP

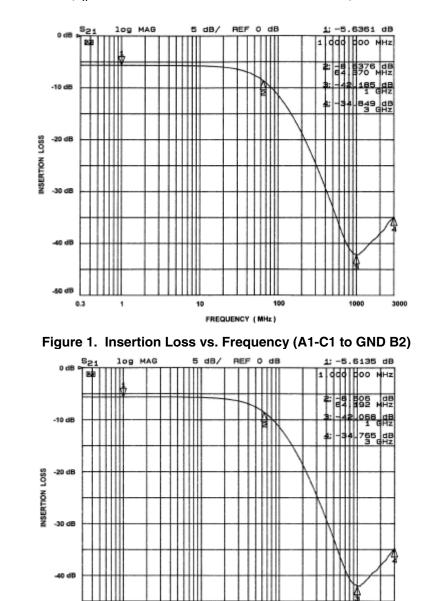
ELECTRICAL OPERATING CHARACTERISTICS (SEE NOTE1)									
SYMBOL	PARAMETER	CONDITIONS	MIN	ТҮР	МАХ	UNITS			
R	Resistance		80	100	120	Ω			
С	Capacitance	At 2.5V DC	24	30	36	pF			
TCR	Temperature Coefficient of Resistance			1200		ppm/°C			
TCC	Temperature Coefficient of Capacitance	At 2.5V DC		-300		ppm/°C			
V	Diode Voltage (reverse bias)	$I_{\text{DIODE}} = 10 \mu A$		6.0		V			
I _{LEAK}	Diode Leakage Current (reverse bias)	V _{DIODE} =3.3V			100	nA			
V _{SIG}	Signal Voltage Positive Clamp Negative Clamp	I _{LOAD} = 10mA	5.6 -1.5	6.8 -0.8	9.0 -0.4	v v			
V _{ESD}	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2 Level 4	Note 3	±30 ±15			kV kV			
V _{CL}	Clamping Voltage during ESD Discharge MIL-STD-883 (Method 3015), 8kV Positive Transients Negative Transients	Notes 2 and 3		+10 -5		v v			
f _c	Cut-off Frequency Z_{SOURCE} =50 Ω , Z_{LOAD} =50 Ω	R=100Ω, C=30pF		58		MHz			

Note 1: $T_A = 25^{\circ}C$ unless otherwise specified.

Note 2: ESD applied to input and output pins with respect to GND, one at a time.

Note 3: Clamping voltage is measured at the opposite side of the EMI filter to the ESD pin. For example, if ESD is applied to Pin A2, then clamping voltage is measured at Pin C2.

Performance Information



Typical Filter Performance (T_A=25°C, DC Bias=0V, 50 Ohm Environment)

Figure 2. Insertion Loss vs. Frequency (A2-C2 to GND B2)

FREQUENCY (MHz)

10

100

1000

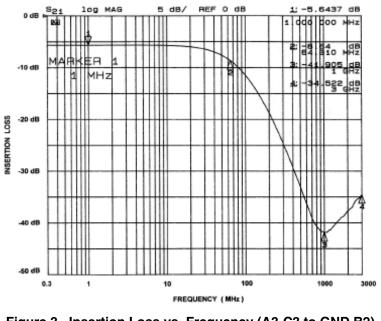
3000

-50 dB ...

1

Performance Information (cont'd)

Typical Filter Performance (T_A=25°C, DC Bias=0V, 50 Ohm Environment)





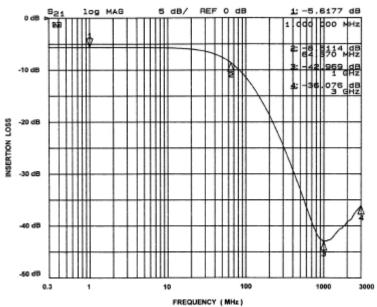


Figure 4. Insertion Loss vs. Frequency (A4-C4 to GND B2)

Performance Information (cont'd)

Typical Filter Performance (T_A=25°C, DC Bias=0V, 50 Ohm Environment)

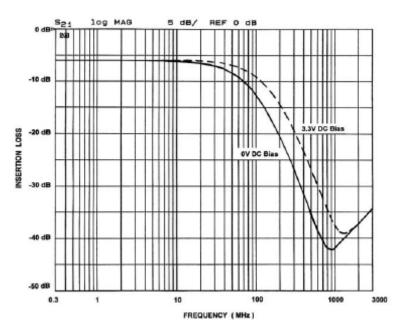


Figure 5. Comparison of Filter Response Curves for CM1400-32CP with DC Bias

Performance Information (cont'd)

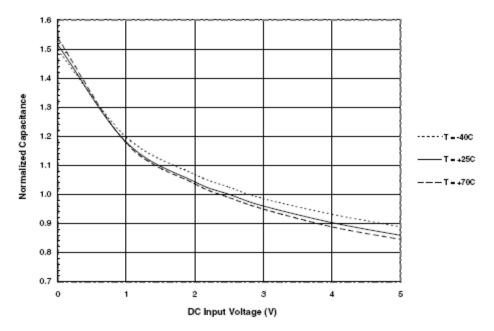
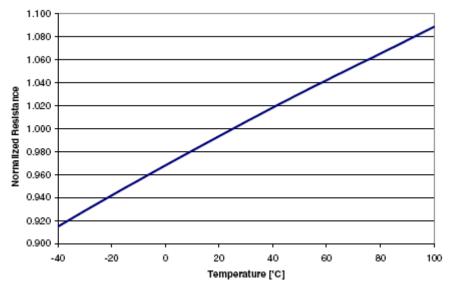
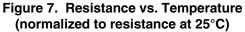


Figure 6. Filter Capacitance vs. Input Voltage over Temperature (normalized to capacitance at 2.5VDC and 25°C)





Application Information

PARAMETER	VALUE
Pad Size on PCB	0.240mm
Pad Shape	Round
Pad Definition	Non-Solder Mask defined pads
Solder Mask Opening	0.290mm Round
Solder Stencil Thickness	0.125mm - 0.150mm
Solder Stencil Aperture Opening (laser cut, 5% tapered walls)	0.300mm Round
Solder Flux Ratio	50/50 by volume
Solder Paste Type	No Clean
Pad Protective Finish	OSP (Entek Cu Plus 106A)
Tolerance — Edge To Corner Ball	<u>+</u> 50μm
Solder Ball Side Coplanarity	<u>+</u> 20μm
Maximum Dwell Time Above Liquidous (183°C)	60 seconds
Maximum Soldering Temperature for Lead-free Devices using a Lead-free Solder Paste	260°C

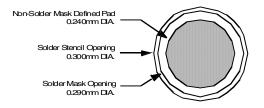


Figure 1. Recommended Non-Solder Mask Defined Pad Illustration

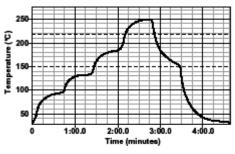


Figure 2. Lead-free (SnAgCu) Solder Ball Reflow Profile

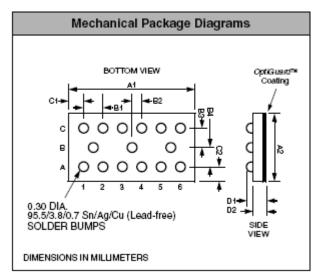
CM1401-32CP

Mechanical Details

CSP Mechanical Specifications

The CM1401-32CP is supplied in a custom Chip Scale Package (CSP). Dimensions are presented below.

PACKAGE DIMENSIONS								
Pack	age	Custom CSP						
Burr	nps	15						
Dim	м	lillimete	ers		Inches			
	Min	Nom	Max	Min	Nom	Max		
A1	2.915	2.960	3.005	0.1148	0.1165	0.1183		
A2	1.285	1.330	1.375	0.0506 0.0524 0.0				
B1	B1 0.495 0.500 0.505		0.0195	0.0197 0.019				
B2 0.245 0.3		0.250	0.255	0.0096	0.0098	0.0100		
B3	0.430	0.435 0.440		0.0169	0.0171	0.0173		
B4	0.430	0.435 0.440		0.0169	0.0171	0.0173		
C1	0.180	0.230	0.280	0.0071 0.0091		0.0110		
C2	0.180	0.230	0.280	0.0071 0.0091		0.0110		
D1	0.575	0.644	0.714	0.0226	0.0254	0.0281		
D2	0.368	0.419	0.470	0.0145	0.0165	0.0185		
# per tape and reel		3500 pieces						
Controlling dimension: millimeters								



Package Dimensions for CM1401-32CP Chip Scale Package

CSP Tape and Reel Specifications

PART NUMBER	CHIP SIZE (mm)	POCKET SIZE (mm) B _o X A _o X K _o	TAPE WIDTH W	REEL DIAMETER	QTY PER REEL	P₀	P ₁
CM1401-32CP	2.96 X 1.33 X 0.644	3.10 X 1.45 X 0.74	8mm	178mm (7")	3500	4mm	4mm

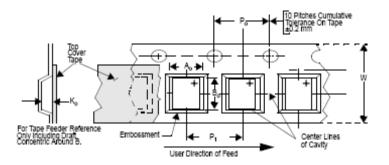


Figure 12. Tape and Reel Mechanical Data

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